

PRELIMINARY DATA SHEET



GaAs HBT INTEGRATED CIRCUIT uPG2314T5N

POWER AMPLIFIER FOR Bluetooth™ Class1

DESCRIPTION

The uPG2314T5N is a GaAs HBT MMIC power amplifier which was developed for Bluetooth™ Class1. This device realizes high efficiency, high gain and high output power by using InGaP HBT. This device is housed in a 6-pin TSON (Thin Small Out-line Non-Leaded) package. And this package is able to high-density surface mounting.

FEATURES

- Operating Frequency : $f_{opt} = 2400$ to 2500 MHz (2450MHz TYP.)
- Supply Voltage : $V_{CC1,2} = 2.7$ to 3.6 V (3.0V TYP.)
- Control Voltage : $V_{cont} = 0$ to 3.6 V (3.0V TYP.)
- : $V_{bias} + V_{enable} = 0$ to 3.1 V (3.0V TYP.)
- Circuit Current : $I_{CC} = 65$ mA TYP. @ $V_{CC1,2} = 3.0$ V, $V_{bias} + V_{enable} = 3.0$ V, $V_{cont} = 3.0$ V, $P_{in} = 0$ dBm
- Output Power : $P_{out} = +20.0$ dBm TYP. @ $V_{CC1,2} = 3.0$ V, $V_{bias} + V_{enable} = 3.0$ V, $V_{cont} = 3.0$ V, $P_{in} = 0$ dBm
- Gain Control Range : GCR = 23dB TYP. @ $V_{CC1,2} = 3.0$ V, $V_{bias} + V_{enable} = 3.0$ V, $V_{cont} = 0$ to 3.0 V, $P_{in} = 0$ dBm
- High Efficiency : PAE = 50% TYP.
- High-density surface mounting : 6-pin TSON package (1.5 × 1.5 × 0.37 mm)

APPLICATION

- Power Amplifier for Bluetooth™ Class1

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
uPG2314T5N – E2	uPG2314T5N – E2 – A	6-pin plastic TSON (Pb-Free)	G5D	<ul style="list-style-type: none"> • Embossed tape 8 mm wide • Pin1,6 face the perforation side of tape • Qty 3kpcs/reel

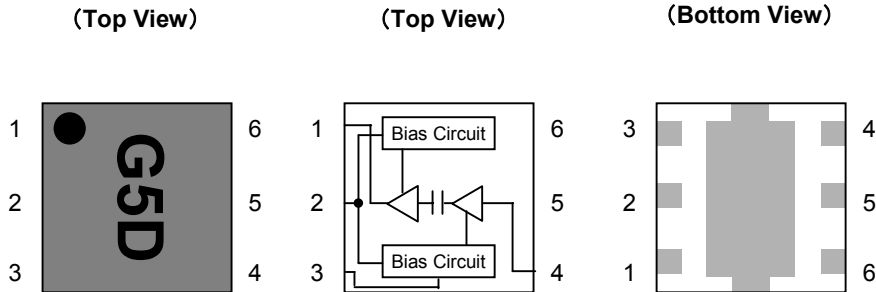
Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order : uPG2314T5N

Caution Electro-static sensitive devices

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.



PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No	Pin Name
1	OUTPUT / V _{CC2}
2	V _{bias} + V _{enable}
3	V _{cont}
4	INPUT
5	V _{CC1}
6	GND

ASOLUTE MAXIMUM RATINGS (Unless otherwise specified, T_A = +25°C)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{CC1,2}	5.5	V
	V _{bias} + V _{enable}	3.6	V
Control Voltage	V _{cont}	3.6	V
Circuit Current	I _{CC}	400	mA
Control Current	I _{cont}	0.5	mA
Input Power	P _{in}	+10	dBm
Power Dissipation	P _D	700 ^{Note}	mW
Operating Ambient Temperature	T _A	-40 ~ + 85	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

Note. Mounted on double copper-clad 50 × 50 × 1.6mm epoxy glass PWB, T_A = +85°C

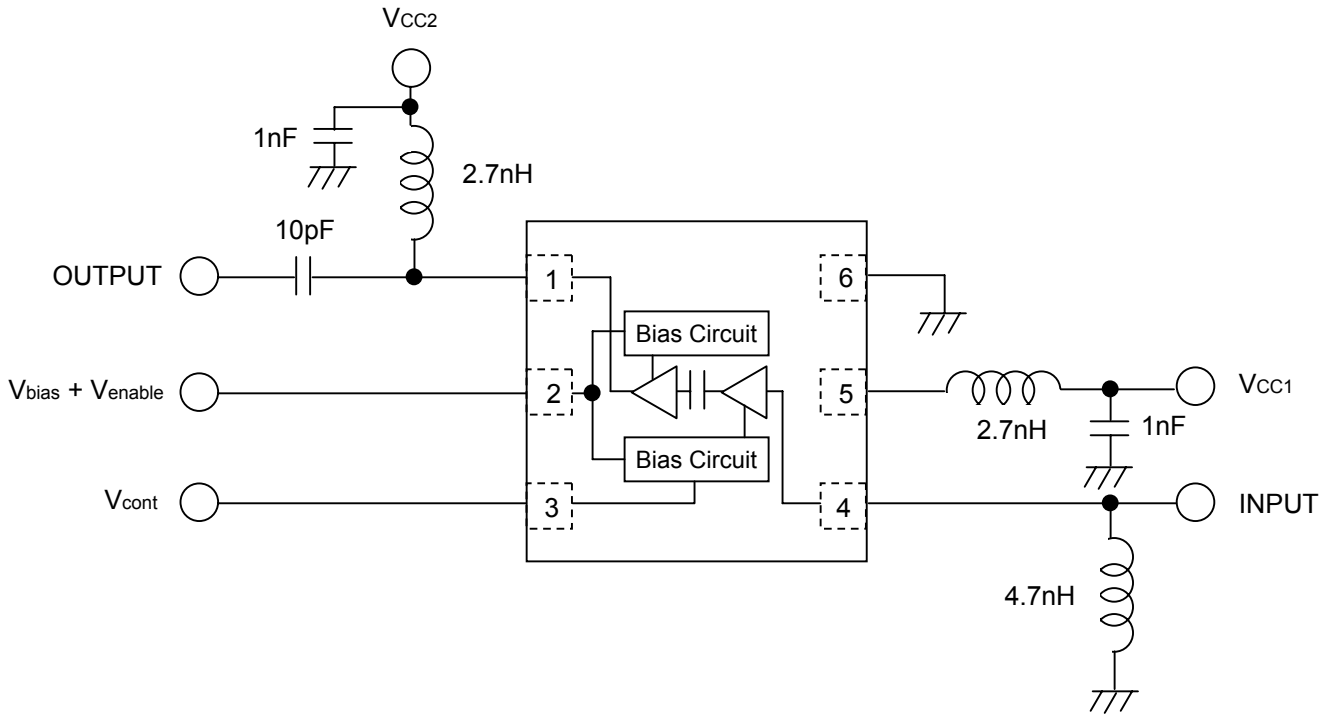
RECOMMENDED OPERATING RANGE (Unless otherwise specified, T_A = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f _{opt}	2400	2450	2500	MHz
Supply Voltage	V _{CC1,VCC2}	2.7	3.0	3.6	V
	V _{bias} + V _{enable}	0	3.0	3.1	V
Control Voltage	V _{cont}	0	3.0	3.6	V

ELECTRICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, $f = 2450\text{MHz}$, $V_{CC1} = V_{CC2} = V_{\text{bias}} + V_{\text{enable}} = 3.0\text{V}$, $P_{\text{out}} = +20\text{dBm}$, External input and output matching, Unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I_{CC}	$V_{\text{cont}} = 3.0\text{V}$, $P_{\text{in}} = 0\text{dBm}$	-	65	70	mA
Shutdown Current	I_{shut}	$V_{\text{cont}} = 3.0\text{V}$, $P_{\text{in}} = 0\text{dBm}$, $V_{\text{bias}} + V_{\text{enable}} = 0\text{V}$	-	0	1	μA
Output Power1	P_{out1}	$V_{\text{cont}} = 3.0\text{V}$, $P_{\text{in}} = 0\text{dBm}$	+18.0	+20.0	-	dBm
Output Power2	P_{out2}	$V_{\text{cont}} = 0\text{V}$, $P_{\text{in}} = 0\text{dBm}$	-	-3.0	+1.0	dBm
Gain Control Range	GCR	$V_{\text{cont}} = 0$ to 3.0V , $P_{\text{in}} = 0\text{dBm}$	17	23	-	dB
Efficiency	PAE	$V_{\text{cont}} = 3.0\text{V}$, $P_{\text{in}} = 0\text{dBm}$	-	50	-	%

EVALUATION CIRCUIT

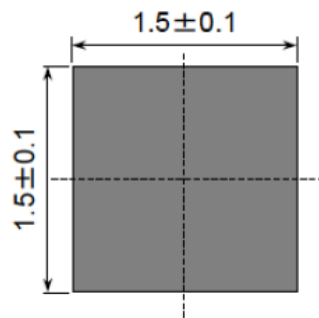


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

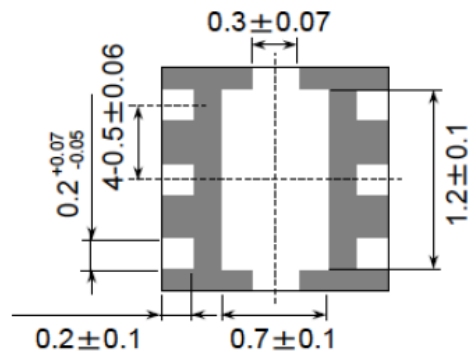
PACKAGE DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)

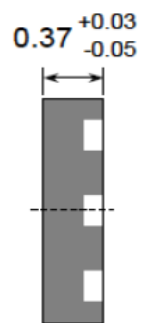
Top View



Bottom View



Side View



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL’s understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
		-A	-AZ
Lead (Pb)	< 1000 PPM	Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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